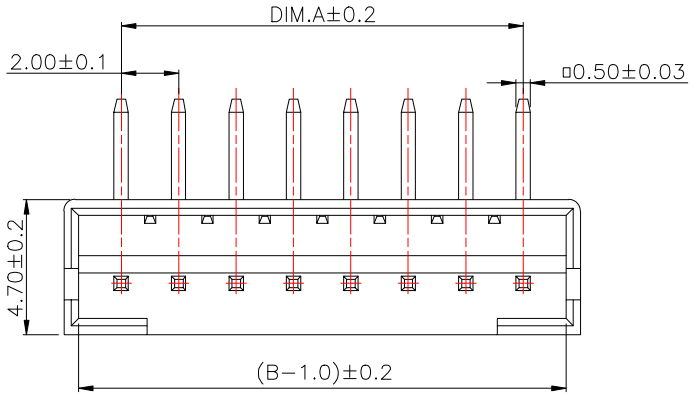
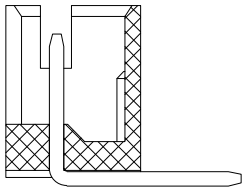
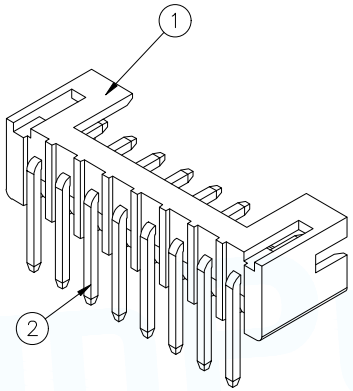
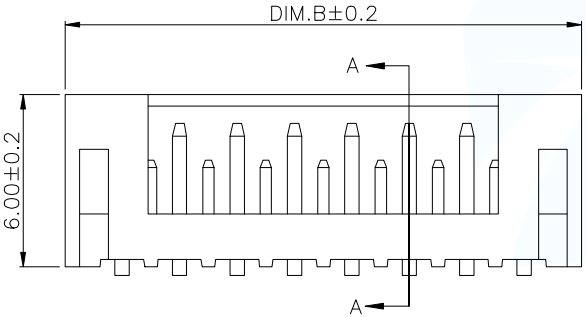
ROHS Compliant

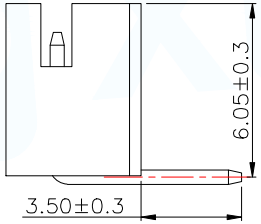
MAPX	MODIFICATION	DATE	DRAW	APPROVE



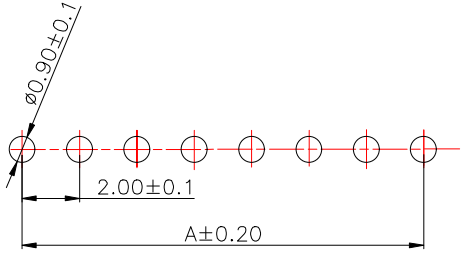

SECTION A–A







Part No	Pin	A	B
WAFER−PH2.0−2PWZ	2	2.00	6.00
WAFER−PH2.0−3PWZ	3	4.00	8.00
WAFER−PH2.0−4PWZ	4	6.00	10.00
WAFER−PH2.0−5PWZ	5	8.00	12.00
WAFER−PH2.0−6PWZ	6	10.00	14.00
WAFER−PH2.0−7PWZ	7	12.00	16.00
WAFER−PH2.0−8PWZ	8	14.00	18.00
WAFER−PH2.0−9PWZ	9	16.00	20.00
WAFER−PH2.0−10PWZ	10	18.00	22.00
WAFER−PH2.0−11PWZ	11	20.00	24.00
WAFER−PH2.0−12PWZ	12	22.00	26.00
WAFER−PH2.0−13PWZ	13	24.00	28.00
WAFER−PH2.0−14PWZ	14	26.00	30.00
WAFER−PH2.0−15PWZ	15	28.00	32.00
WAFER−PH2.0−16PWZ	16	30.00	34.00
WAFER−PH2.0−17PWZ	17	32.00	36.00
WAFER−PH2.0−18PWZ	18	34.00	38.00
WAFER−PH2.0−19PWZ	19	36.00	40.00
WAFER−PH2.0−20PWZ	20	38.00	42.00



SUGGESTED PCB LAYOUT

(COMPONENT SIDE)

技术要求:

1.塑件材料:PA66(UL−94V−0)

2.接触件:黄铜镀锡

3.接触电阻:≤10mΩ

4.绝缘电阻:≥100MΩ

5.额定电压:250V AC DC

6.额定电流:2.0A AC DC

7.耐压:能承受1000V AC/Minute

8.工作温度:−25°~+85°

9.可焊性试验:浸锡面积≥95%温度235±5°,时间2.5±0.5秒

10.铅和镉等六大有害物质含量要符合环保要求.

序号	名称	材料	数量	备注
2	端子Contact	黄铜	N*1	电镀(锡):整个表面镀底镍30u"MIN,再镀锡80u"MIN
1	基座Wafer	PA66(UL94 V−0)	1	白色

MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co,Ltd			
UNLESS OTHERWISE SPECIFED TOLERANCES			TITLE: WAFER PH2.0MM 弯针		
			PAR	WAFER−PH2.0−NPWZ	
DECIMALS:	ANGLES:		DWN		
.X±0.20	±2°		CHKD		
.XX±0.10			APVD		
.XXX±0.05		CUSTOMER COPY	SCALE1:1	UNIT:MM	
			SIZE:A4	SHEET:1F1	REV:A

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Global Electronic Components Distributor

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XUNPU:

FPC-0.5AL-6PB FPC-0.5FX-14PWCR-H20 FPC-0.5FX-4PWBH15 WAFER-PH2.0-11PZZ
WAFER-PH2.0-6PWB WAFER-PH2.0-8PLB WAFER-WBM4.2-16PJK-GB WAFER-XH2.54-4PWZ-H62
DC-031A-A100 FPC-0.5AS-5PWCR-H20 WAFER-PH2.0-3PWB FPC-0.5AX-24PWCR-H20
FPC-0.5HF-10PWBR-H20 WAFER-VH3.96-4PLB FPC-0.5FX-16PWCR-H20 FPC-1.0AX-4PWCR-H25
MU-103-ARW64 SMA-KWE-323C-H13X23-LW WAFER-MX1.25B-8PWB WAFER-PH2.0-2PJK
FPC-0.5AX-30PWCR-H20 FPC-0.5FX-4PWCR-H20 FPC-1.0HF-4PWAR-H20 RJ45-005-014-11
WAFER-GH1.25-6PLB FPC-0.5FX-20PWBH15 FPC-1.0AX-14PWCR-H25 HDMI-212L PHB2.0-02-20PZZ
TYPEC-304YDSW-ACP16